

Dual N-channel MOSFET

ELM14800AA-N

■General description

ELM14800AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

■Features

- $V_{ds}=30V$
- $I_d=6.9A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 27m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 32m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 50m\Omega$ ($V_{gs}=2.5V$)

■Maximum absolute ratings

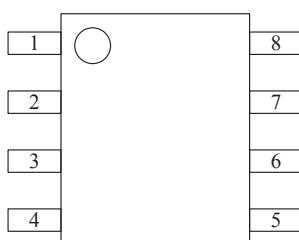
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	30	V	
Gate-source voltage	V_{gs}	± 12	V	
Continuous drain current	I_d	6.9	A	1
		5.8		
Pulsed drain current	I_{dm}	40	A	2
Power dissipation	P_d	2.00	W	
		1.44		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	48.0	62.5	°C/W	1
Maximum junction-to-ambient	Steady-state		74.0	110.0	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	35.0	40.0	°C/W	3

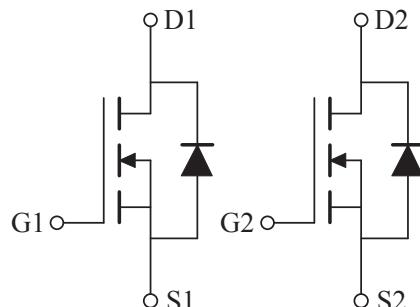
■Pin configuration

SOP-8(TOP VIEW)



Pin No.	Pin name
1	SOURCE2
2	GATE2
3	SOURCE1
4	GATE1
5	DRAIN1
6	DRAIN1
7	DRAIN2
8	DRAIN2

■Circuit



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■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit	
STATIC PARAMETERS								
Drain-source breakdown voltage	BVdss	Id=250μA, V _{gs} =0V		30			V	
Zero gate voltage drain current	Idss	V _{ds} =24V, V _{gs} =0V	T _j =55°C		0.002	1.000	μA	
						5.000		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±12V				100	nA	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , Id=250μA		0.7	1.0	1.4	V	
On state drain current	I _{d(on)}	V _{gs} =4.5V, V _{ds} =5V		25			A	
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =10V, Id=6.9A			22.6	27.0	mΩ	
				T _j =125°C	33.0	40.0		
		V _{gs} =4.5V, Id=6A			27.0	32.0	mΩ	
		V _{gs} =2.5V, Id=5A			42.0	50.0	mΩ	
Forward transconductance	G _{fs}	V _{ds} =5V, Id=5A		12	16		S	
Diode forward voltage	V _{sd}	Is=1A			0.71	1.00	V	
Max. body-diode continuous current	I _s					3	A	
DYNAMIC PARAMETERS								
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =15V, f=1MHz			858	1050	pF	
Output capacitance	C _{oss}				110		pF	
Reverse transfer capacitance	C _{rss}				80		pF	
Gate resistance	R _g	V _{gs} =0V, V _{ds} =0V, f=1MHz			1.24	3.60	Ω	
SWITCHING PARAMETERS								
Total gate charge	Q _g	V _{gs} =4.5V, V _{ds} =15V, Id=6.9A			9.60	12.00	nC	
Gate-source charge	Q _{gs}				1.65		nC	
Gate-drain charge	Q _{gd}				3.00		nC	
Turn-on delay time	t _{d(on)}	V _{gs} =10V, V _{ds} =15V R _l =2.2Ω, R _{gen} =3Ω			3.2	4.8	ns	
Turn-on rise time	t _r				4.1	6.2	ns	
Turn-off delay time	t _{d(off)}				26.3	40.0	ns	
Turn-off fall time	t _f				3.7	5.5	ns	
Body diode reverse recovery time	t _{rr}	I _f =5A, dI/dt=100A/μs			15.5	20.0	ns	
Body diode reverse recovery charge	Q _{rr}	I _f =5A, dI/dt=100A/μs			7.9	12.0	nC	

NOTE :

- The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
- The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
- These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics

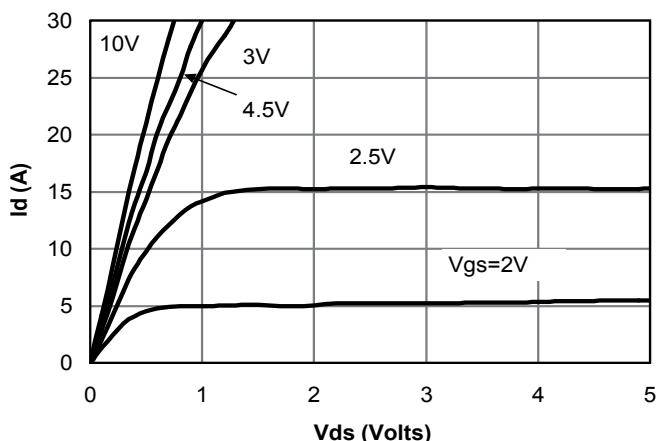


Fig 1: On-Region Characteristics

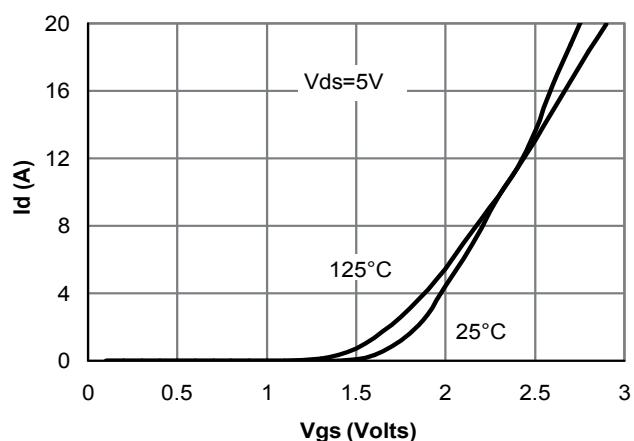


Figure 2: Transfer Characteristics

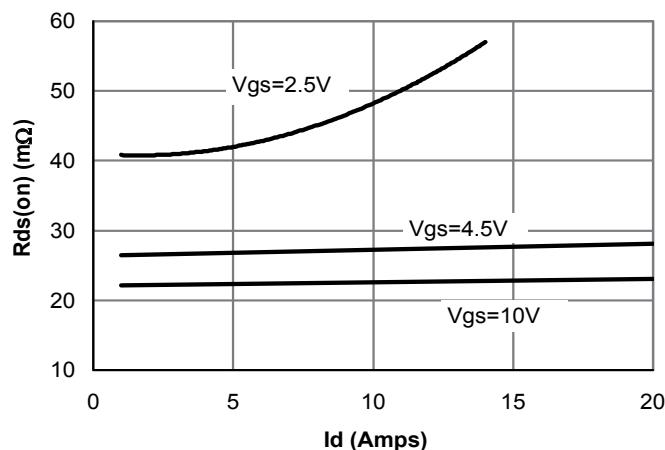


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

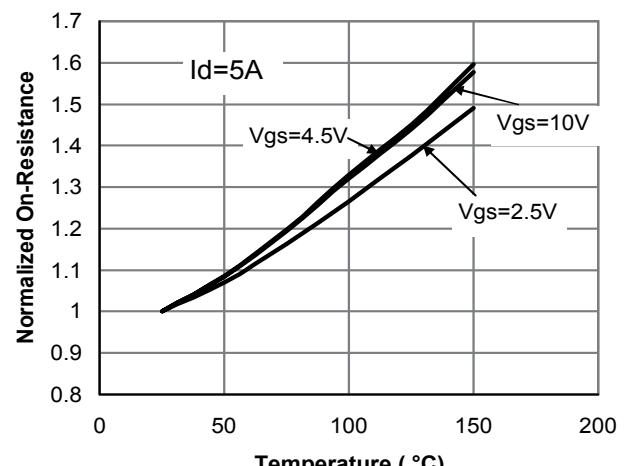


Figure 4: On-Resistance vs. Junction Temperature

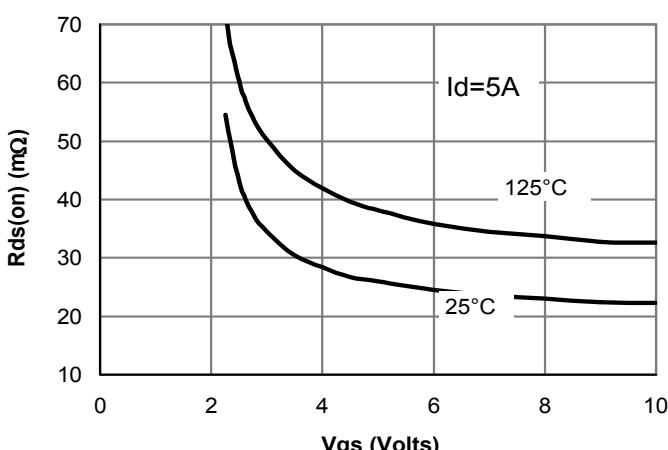


Figure 5: On-Resistance vs. Gate-Source Voltage

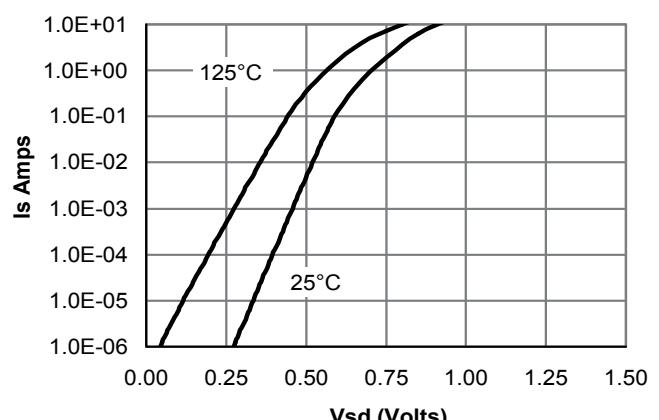


Figure 6: Body diode characteristics

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